

MJ P-Channel Enhancement Mode Power MOSFET

Description

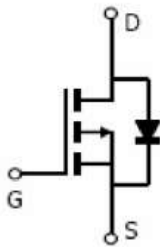
The MJ60P40K uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

General Features

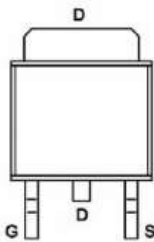
- ◆ $V_{DS} = -60V, I_D = -40A$
 $R_{DS(ON)} < 23m\Omega @ V_{GS} = -10V$
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation

Application

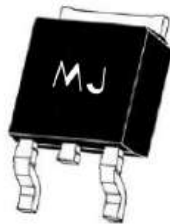
- ◆ Power switching application
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply



Schematic diagram



Marking and pin assignment



TO-252-2L top view

100% UIS TESTED! 100% ΔV_{ds} TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ60P40K	MJ60P40K	TO-252-2L	-	-	-

Absolute Maximum Ratings (Tc =25 °Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-60	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	-40	A
Drain Current-Continuous(Tc =100°C)	$I_{D(100^{\circ}C)}$	-28.3	A
Pulsed Drain Current	I_{DM}	160	A
Maximum Power Dissipation	P_D	100	W
Derating factor		0.67	W/°C
Single pulse avalanche energy (Note 5)	E_{AS}	420	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case (Note 2)	$R_{\theta JC}$	1.5	°C/W
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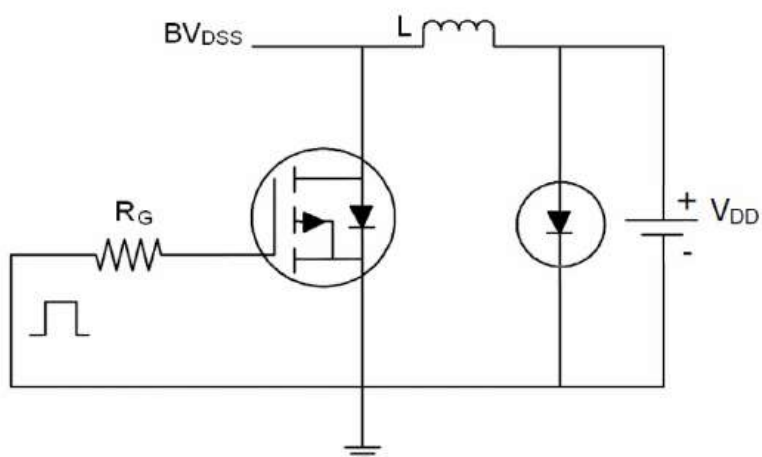
Electrical Characteristics (T_c =25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics <small>(Note 3)</small>						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-2	-2.6	-4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	19	23	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-5V,I _D =-20A	-	20	-	S
Dynamic Characteristics <small>(Note 4)</small>						
Input Capacitance	C _{iss}	V _{DS} =-30V,V _{GS} =0V F=1.0MHz	-	5410	-	PF
Output Capacitance	C _{oss}		-	450	-	PF
Reverse Transfer Capacitance	C _{rss}		-	234	-	PF
Switching Characteristics <small>(Note 4)</small>						
Turn-on Delay Time	t _{d(on)}	V _{DD} =-30V,I _D =-20A V _{GS} =-10V,R _{GEN} =3Ω	-	16	-	nS
Turn-on Rise Time	t _r		-	18	-	nS
Turn-Off Delay Time	t _{d(off)}		-	65	-	nS
Turn-Off Fall Time	t _f		-	22	-	nS
Total Gate Charge	Q _g	V _{DS} =-30V,I _D =-20A V _{GS} =-10V	-	89.5	-	nC
Gate-Source Charge	Q _{gs}		-	19	-	nC
Gate-Drain Charge	Q _{gd}		-	22	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage <small>(Note 3)</small>	V _{SD}	V _{GS} =0V,I _S =-12A	-	-	1.2	V
Diode Forward Current <small>(Note 2)</small>	I _S		-	-	-40	A
Reverse Recovery Time	t _{rr}	T _J =25°C, I _F =-20A di/dt= 100A/μs <small>(Note 3)</small>	-	-	71	nS
Reverse Recovery Charge	Q _{rr}		-	-	170	nC

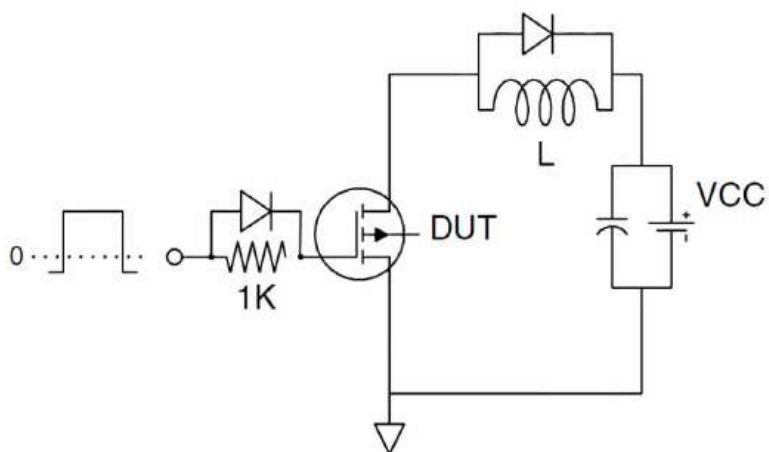
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production
- ⑤ EAS condition: T_J=25℃, V_{DD}=-30V,V_G=-10V,L=0.5mH,R_g=25Ω

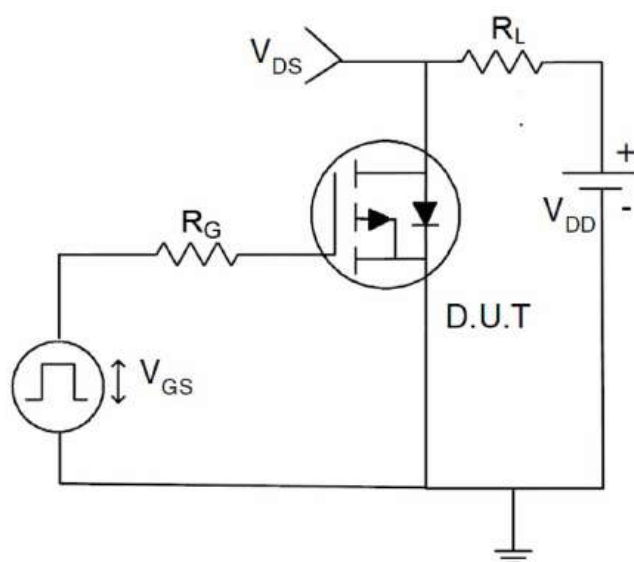
Test circuit



EAS test Circuit

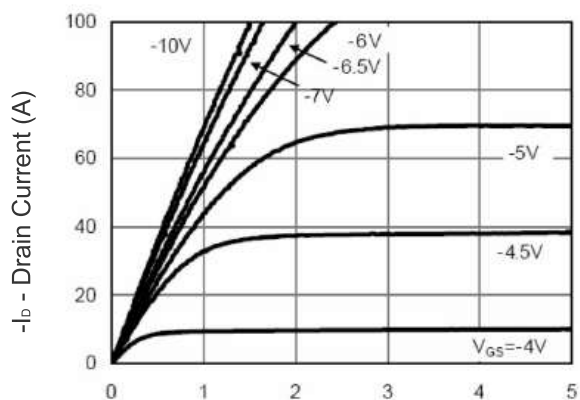


Gate charge test Circuit



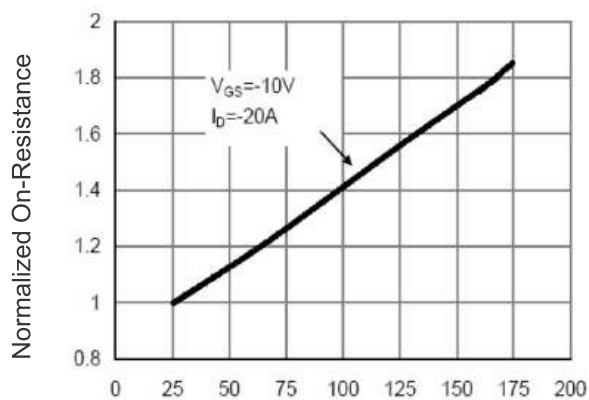
Switch Time Test Circuit

Typical Electrical and Thermal Characteristics (Curves)



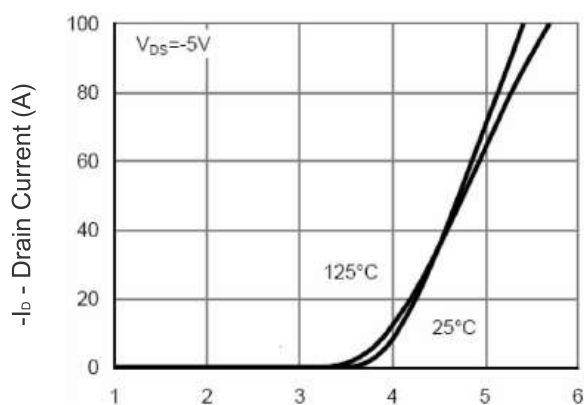
-V_{DS} Drain-Source Voltage (V)

Figure 1 Output Characteristics



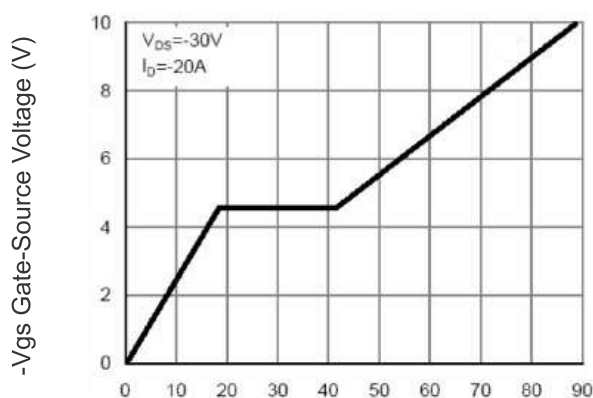
T_J -Junction Temperature(°C)

Figure 4 R_{DS(on)}-Junction Temperature



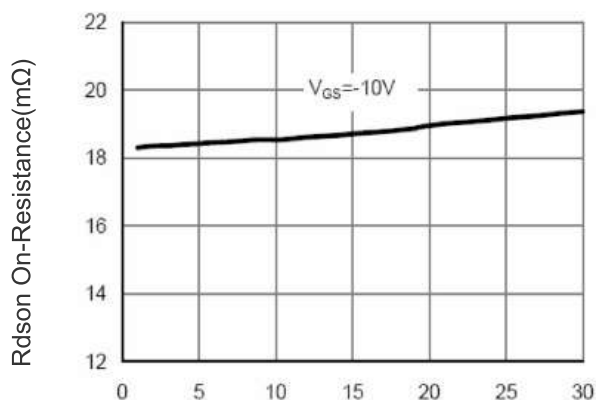
-V_{GS} Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



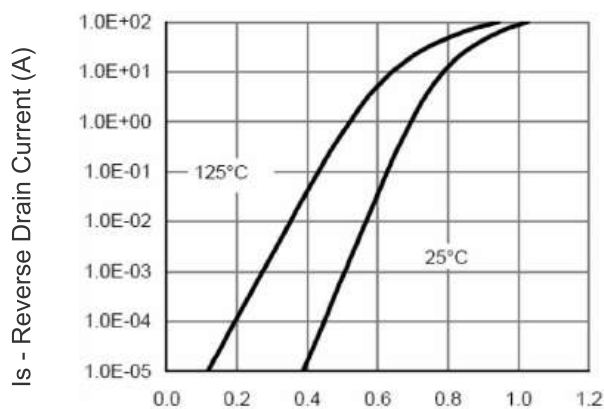
Q_g Gate Charge (nC)

Figure 5 Gate Charge



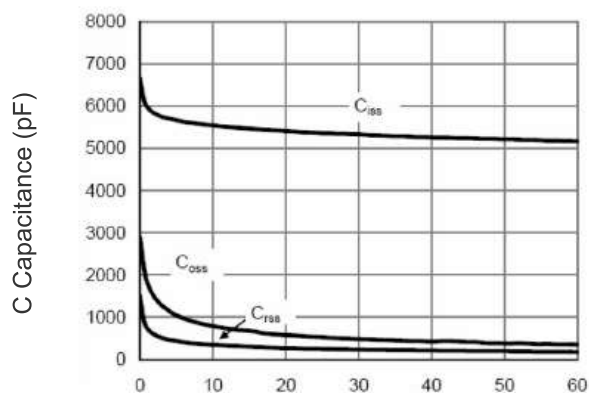
-I_D - Drain Current (A)

Figure 3 R_{DS(on)}- Drain Current



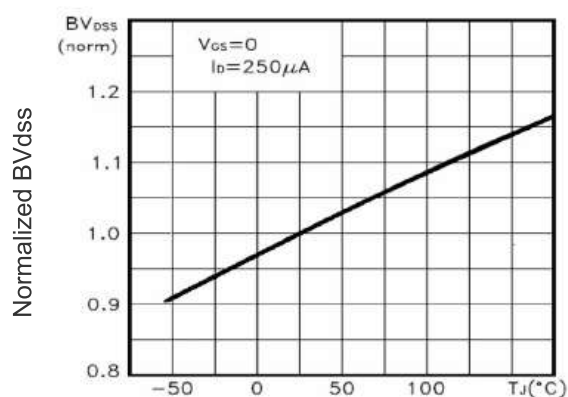
-V_{SD} Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



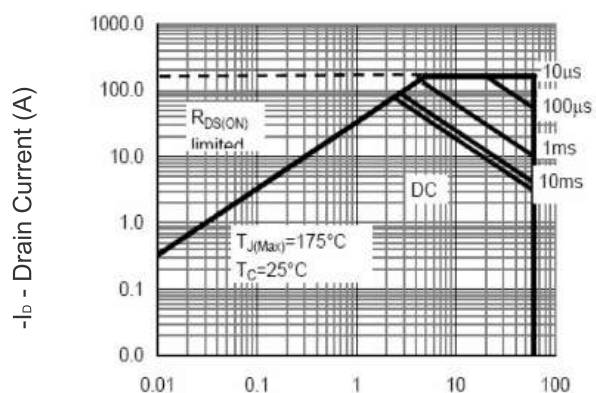
-Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



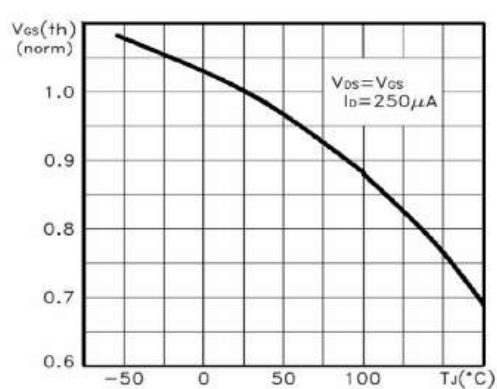
TJ - Junction Temperature(°C)

Figure 9 BV_{DSS} vs Junction Temperature



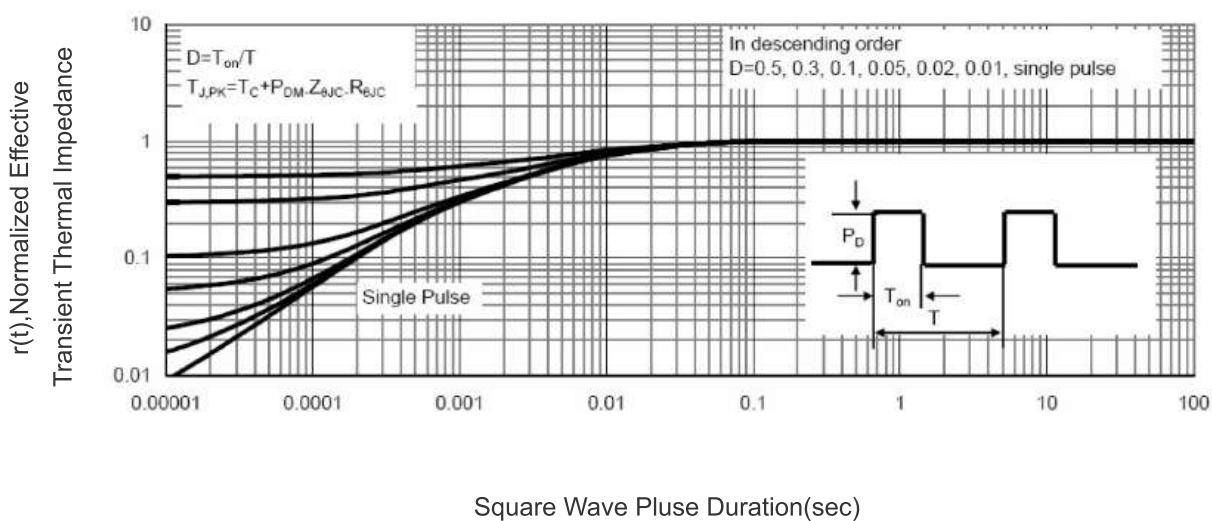
-Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



TJ - Junction Temperature(°C)

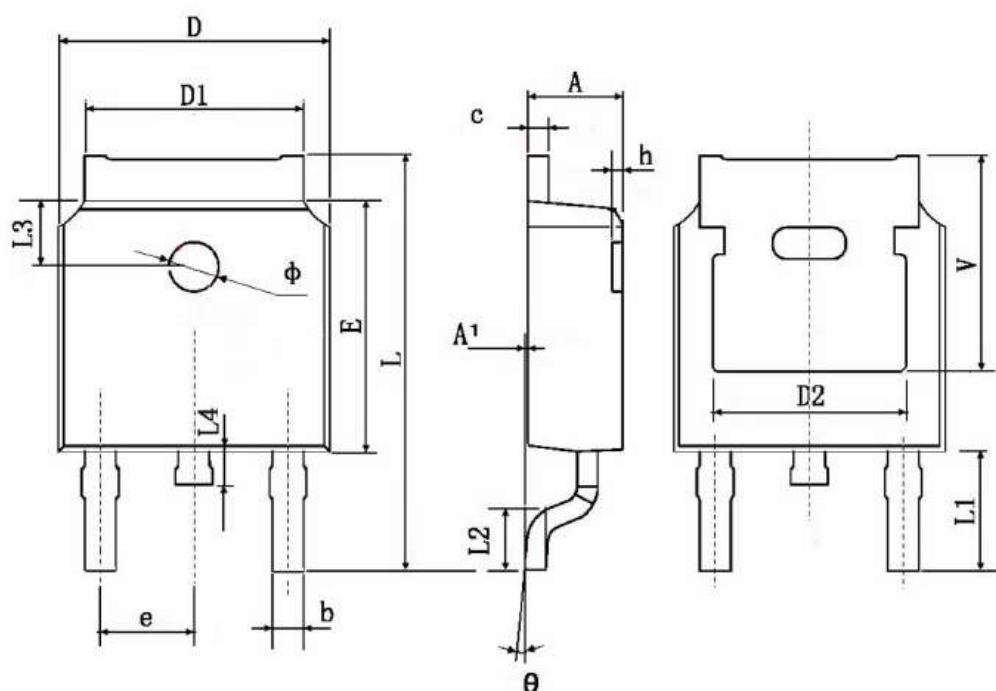
Figure 10 V_{GS(th)} vs Junction Temperature



Square Wave Pulse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	

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